

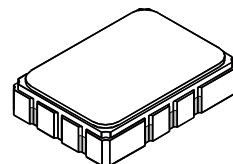
- **Designed for SDARS Receiver IF Application**
- **Low Insertion Loss**
- **5.0 X 7.0 mm Surface-Mount Case**
- **Differential Input and Output**

#### Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range	-40 to +105	°C
Suitable for lead-free soldering - Max Soldering Temperature	260°C for 30 s	

**SF2025B**

**259.861 MHz  
SAW Filter**



**SMP-03**

#### Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	$f_c$	1	259.861			MHz
Passband	IL	1, 2		13.3	15.5	dB
Minimum Insertion Loss				13.8		MHz
1.5 dB Passband	BW <sub>1.5</sub>			14.5		
3 dB Passband	BW <sub>3</sub>					
Amplitude Ripple from fc-6.354 MHz to fc-4.2885 MHz (-20 to 85°C)					1	dB <sub>P-P</sub>
Amplitude Ripple from fc-6.354 MHz to fc-4.2885 MHz (-40 to -20°C)					1.5	
Amplitude Ripple from fc-4.4965 MHz to fc-2.431 MHz					1	
Amplitude Ripple from fc-2.639 MHz to fc+0.079 MHz					1	
Amplitude Ripple from fc-0.079 MHz to fc+2.639 MHz					1	
Amplitude Ripple from fc+2.431 MHz to fc+4.4965 MHz					1	
Amplitude Ripple from fc+4.2885 MHz to fc+6.354 MHz (-40 to 60°C)					1	
Amplitude Ripple from fc+4.2885 MHz to fc+6.354 MHz (60 to 85°C)					1.15	
Group Delay Variation over fc-6.354 MHz to fc-2.431 MHz and from fc+2.431 MHz to fc+6.354 MHz	GDV1	1, 2, 3		40	60	ns <sub>P-P</sub>
Group Delay Variation over fc±2.639 MHz	GDV2			40	120	
Rejection		1, 2, 3	36	43		dB
fc-28 to fc-12 MHz and fc+12 to fc+33 MHz			30	40		
fc-12 to fc-10.5 MHz fc+9 to fc+12 MHz			18	36		
Operating Temperature Range	T <sub>A</sub>	1	-40		+85	°C
Frequency Temperature Coefficient				-18		ppm/°C
Differential Input and Output Impedance	L & C Match to 150 ohms					
Case Style		6	SMP-03 7 x 5 mm Nominal Footprint			
Lid Symbolization (YY=year, WW=week, S=shift) See note 4			RFM SF2025B YYWWS			

#### Electrical Connections

Connection	Terminals
Port 1 Hot	10
Port 1 Ground Return	1
Port 2 Hot	5
Port 2 Ground Return	6
Case Ground	All Others



**CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

**Notes:**

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Tape and Reel Standard Per ANSI / EIA 481.
7. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
8. US and international patents may apply.
9. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

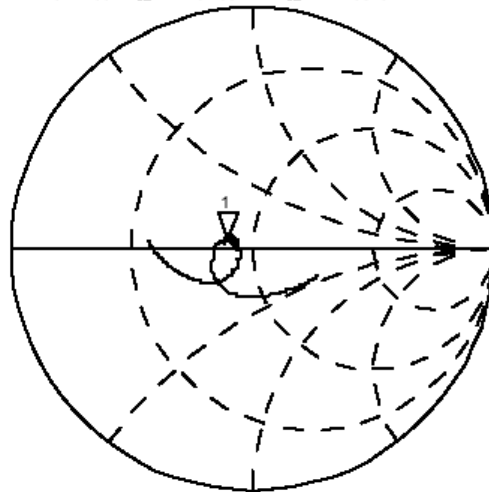
CH1 S11 1 UFS 1: 40.799 3.3672 2.0623 nH 259.861000 MHz

hp

Cor

PRm

HLd



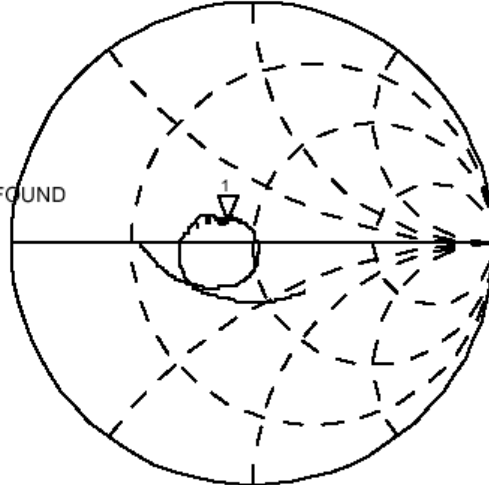
CH2 S22 1 UFS 1: 39.922 7.5566 4.6282 nH 259.861000 MHz

Cor

CH2 TARGET VALUE NOT FOUND

PRm

HLd



CH2 Markers

BW: 0.000000 MHz

cent: 0.000000 MHz

Q: 0.0000

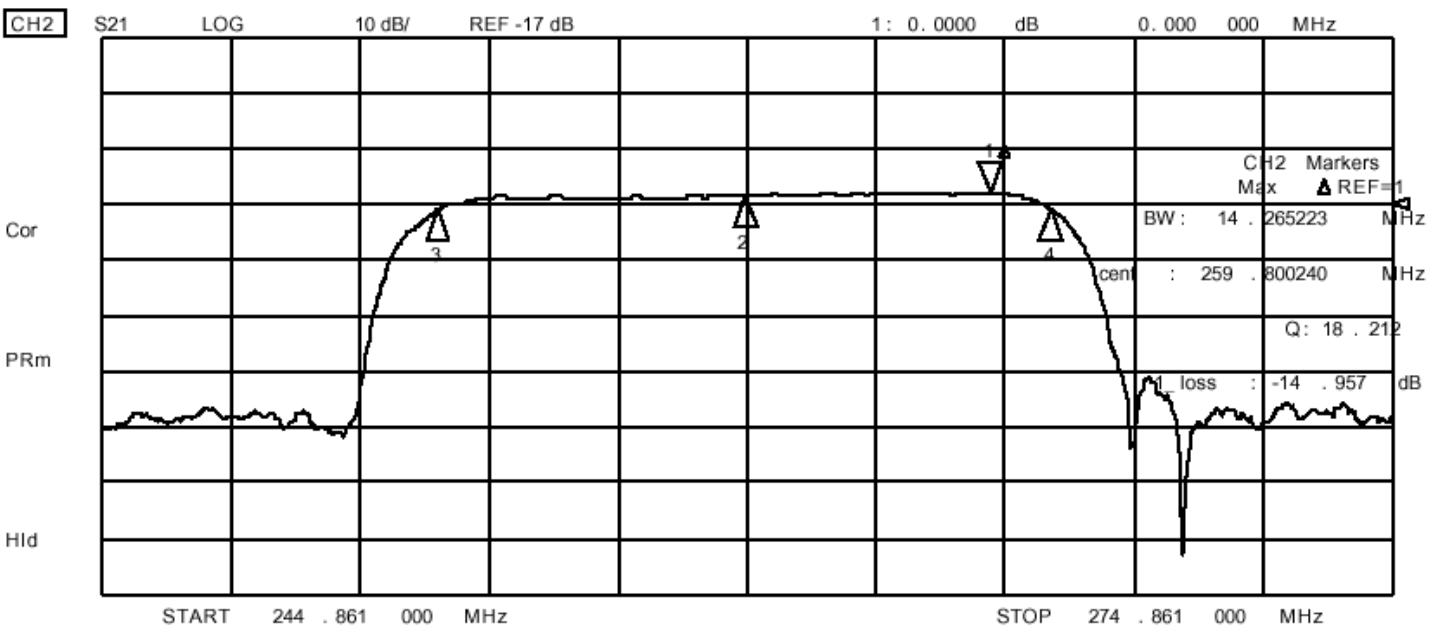
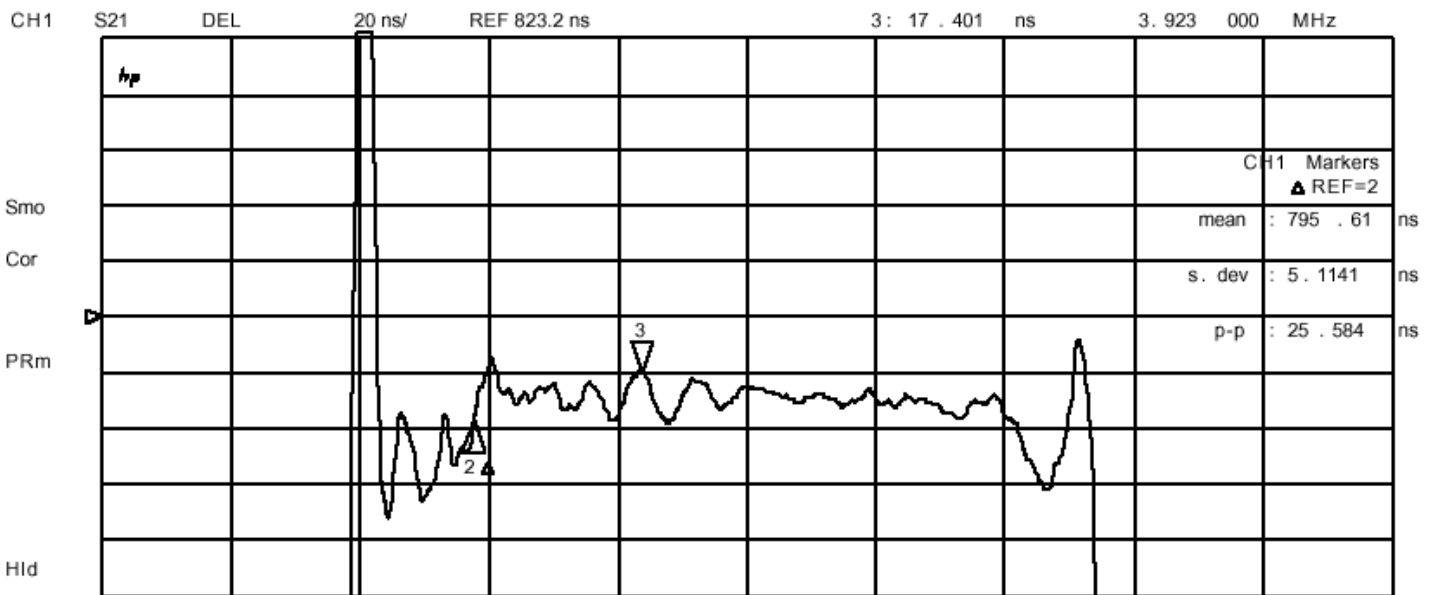
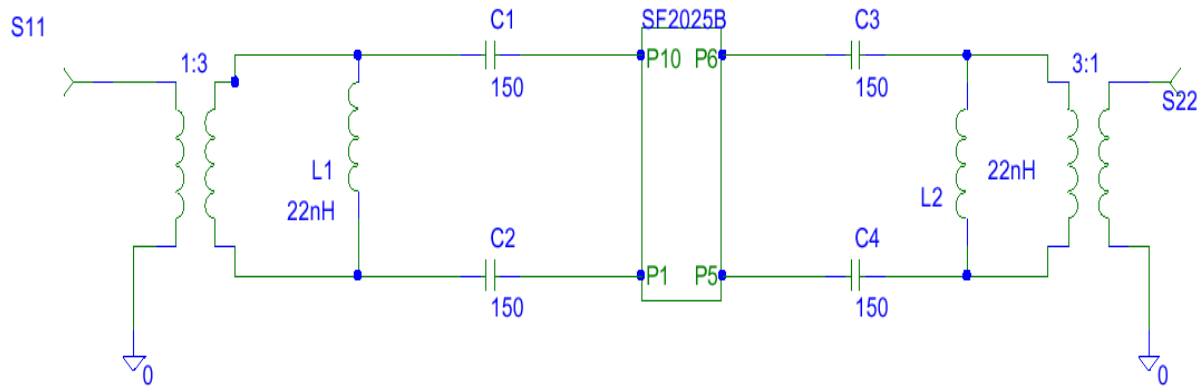
1\_loss: 39.922 nH

START 244.861000 MHz

STOP 274.861000 MHz

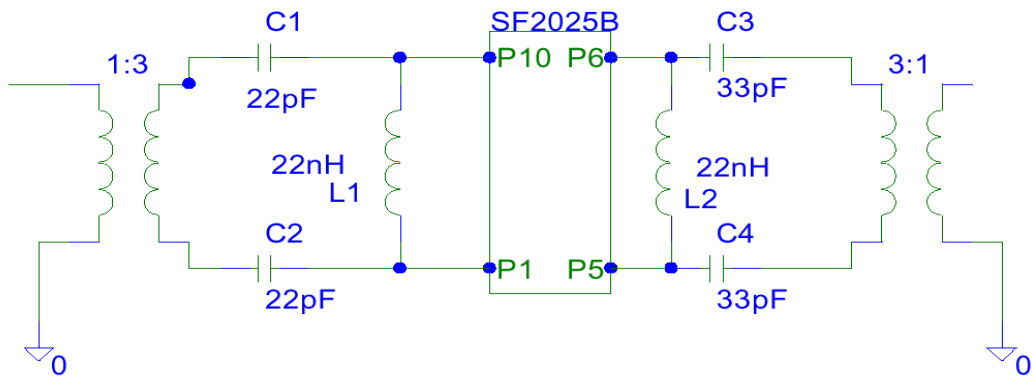
**SF2025B**  
**50 Ohm System**

## Matching Circuits



# Matching Circuits

better rejection tuning



CH1 S11 1 UFS 1: 50 . 018 11 . 121 6. 8112 nH 259 . 861 000 MHz

hp

Cor

PRm

Hid

CH2 S22 1 UFS

1: 42 . 555 11 . 117 6. 8089 nH 259 . 861 000 MHz

Cor

CH2 TARGET VALUE NOT FOUND

PRm

Hid

CH2 Markers

BW: 0. 000000 MHz

cent : 0. 000000 MHz

Q: 0. 0000

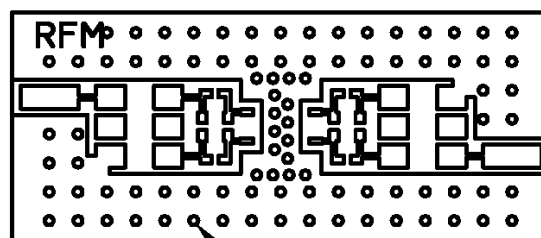
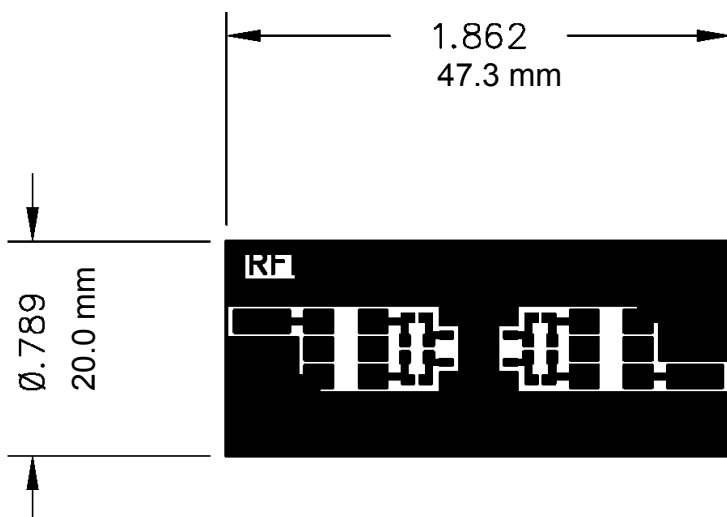
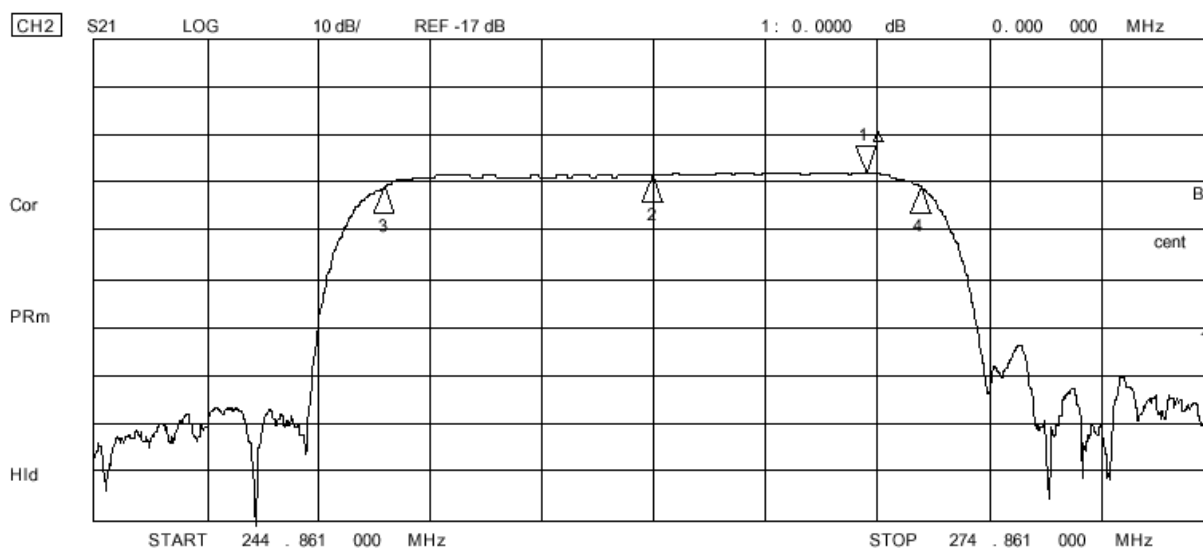
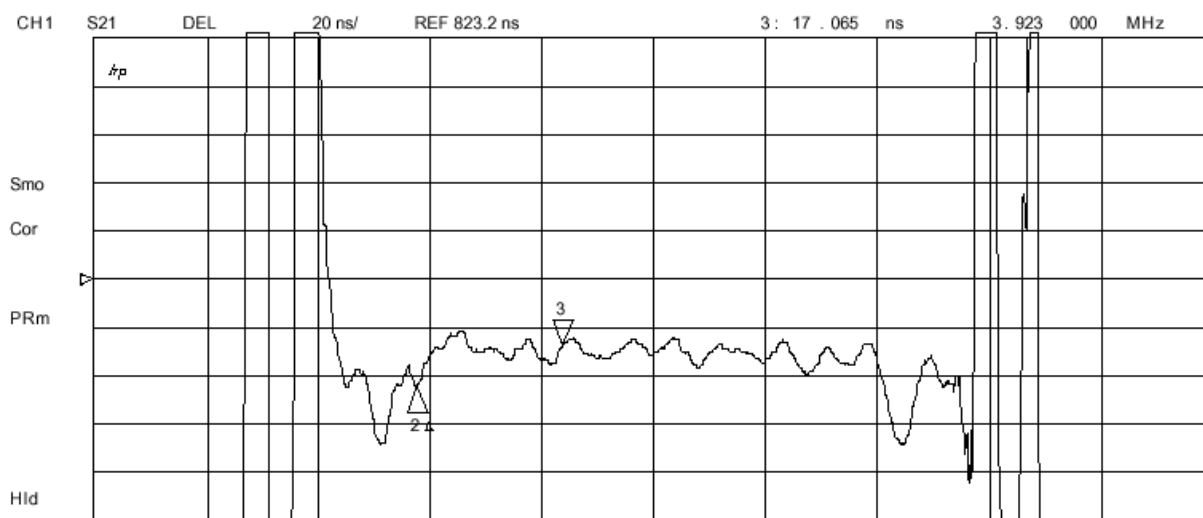
1\_loss : 42 . 555  $\Omega$

START 244 . 861 000 MHz

STOP 274 . 861 000 MHz

**SF2025B**  
**50 Ohm System**

22 Dec 2003 16:58:01

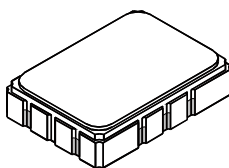


ALL HOLES PLATED THRU -  $\phi$ 1/32 DRILL

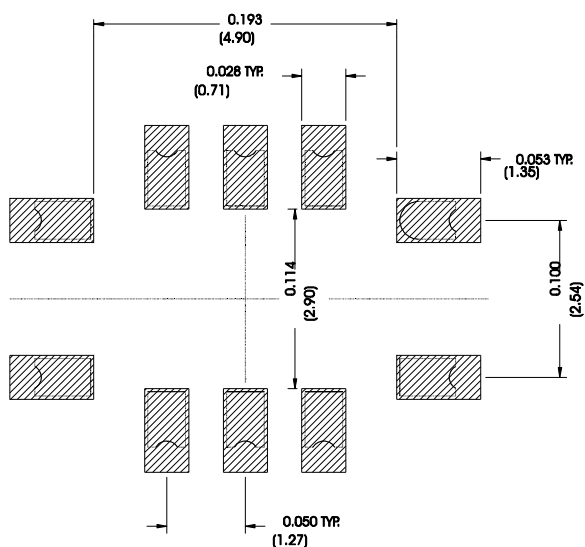
# SMP-03 Case

## 10-Terminal Ceramic Surface-Mount Case

### 7 x 5 mm Nominal Footprint



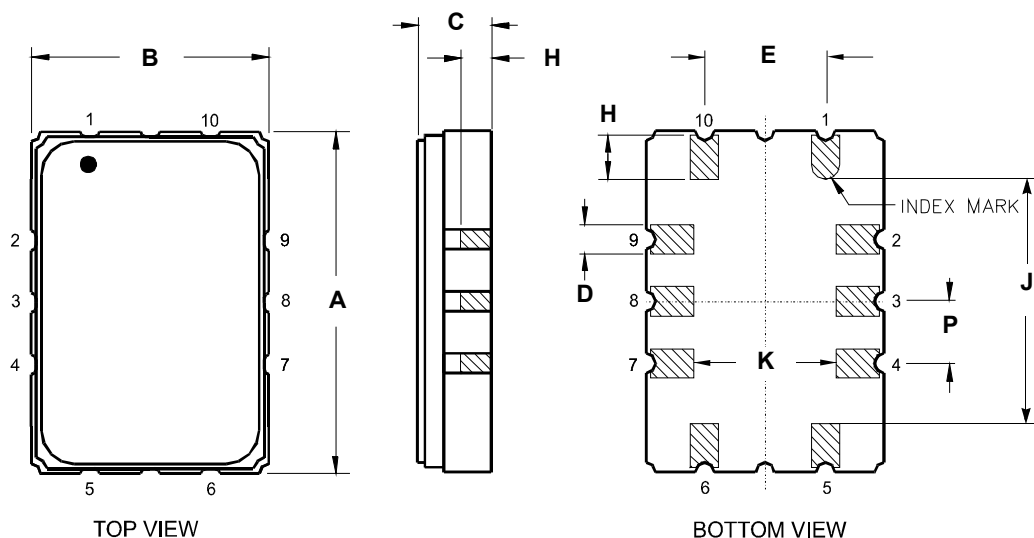
Recommended PCB Footprint



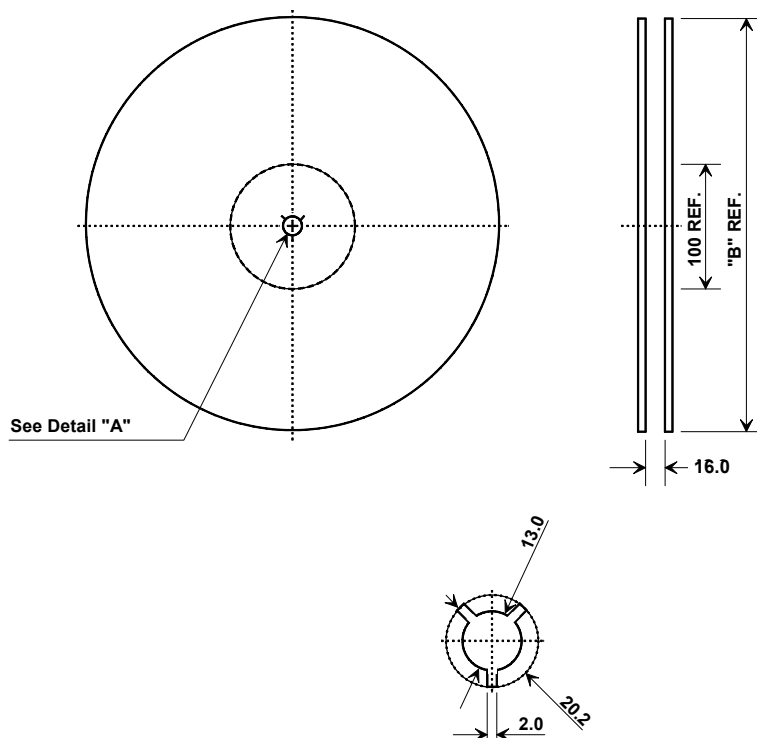
Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	6.80	7.00	7.20	0.268	0.276	0.283
B	4.80	5.00	5.20	0.189	0.197	0.205
C		1.65	2.00		0.065	0.079
D	.47	0.60	.73	0.019	0.024	0.029
E	2.41	2.54	2.67	0.095	0.100	0.105
H	0.87	1.0	1.13	0.034	0.039	0.044
J	4.87	5.00	5.13	0.192	0.197	0.202
K	2.87	3.00	3.13	0.113	0.118	0.123
P	1.14	1.27	1.40	0.045	0.050	0.055

Materials	
Solder Pad Termination	Au plating 30 - 60 μmches (76.2-152 μm) over 80-200 μmches (203-508 μm) Ni.
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 μmches Thick
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic
Pb Free	

Electrical Connections		
Connection		Terminals
Port 1	Input or Return	10
	Return or Input	1
Port 2	Output or Return	5
	Return or Output	6
Ground		All others
Single Ended Operation		Return is ground
Differential Operation		Return is hot



## Tape and Reel Specifications



"B"		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	2000

### COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	5.5 mm
Bo	7.5 mm
Ko	2.0 mm
Pitch	8.0 mm
W	16.0 mm

